

Title (en)  
PD AND PD-NI ELECTROLYTE BATHS

Title (de)  
PD- UND PD-NI-ELEKTROLYTBÄDER

Title (fr)  
BAINS D'ÉLECTROLYTE AU PD ET AU PD-NI

Publication  
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Application  
**EP 08758401 A 20080507**

Priority  
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Abstract (en)  
[origin: WO2009135505A1] The present invention relates to an electrolyte for the galvanic deposition of palladium or palladium alloys on metal or conductive substrates. The invention further relates to a corresponding galvanising method using said electrolyte, and to specific palladium salts that are advantageously used for said method.

IPC 8 full level  
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